



BS107P

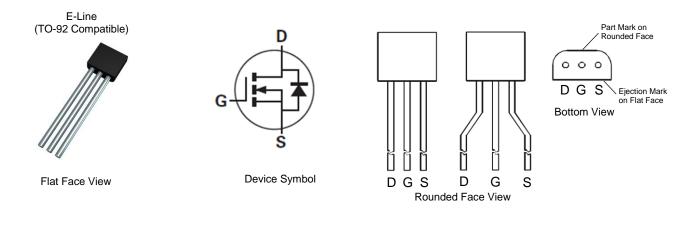
200V N-CHANNEL ENHANCEMENT MODE VERTICAL DMOSFET

Features

- BV_{DSS} > 200V
- $R_{DS(ON)} \le 23\Omega @ V_{GS} = 2.6V$
- I_D = 120mA Maximum Continuous Drain Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: E-Line (TO-92 Compatible)
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Rating 94V-0
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.159 grams (Approximate)



Ordering Information (Note 4)

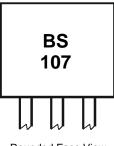
Product	Marking	Package	Leads	Quantity
BS107P	BS107	E-Line	Straight	4,000 Loose in a Box
BS107PSTZ	BS107	E-Line	Joggled	2,000 Taped per Ammo Box

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



BS107 = Product Type Marking Code

See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	200	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current	ID	120	mA
Pulsed Drain Current	I _{DM}	2	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	PD	500	mW
Thermal Resistance, Junction to Ambient	(Note 5)	R _{θJA}	200	°C/W
Thermal Resistance, Junction to Leads	(Note 6)	R _{θJL}	71	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

^{5.} For a through-hole device mounted on the minimum recommended pad layout with 12mm lead length from the bottom of package to the single-sided Notes: FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
Thermal resistance from junction to solder-point at the seating plane (2.5mm from the bottom of package along the drain lead).

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	200	230		V	$I_{D} = 100 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	IDSS	_	_	30	nA	$V_{DS} = 130V, V_{GS} = 0V$
Drain Cut-Off Current	I _{DSX}	_	_	1	μA	$V_{DS} = 70V, V_{GS} = 0.2V$
Gate-Source Leakage	I _{GSS}	_	_	±10	nA	$V_{GS} = \pm 15 V, V_{DS} = 0 V$
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	3.0	V	$I_D = 1mA$, $V_{DS} = V_{GS}$
Statia Drain Source On Registence (Note 7)		_	15	23	Ω	$V_{GS} = 2.6V, I_D = 25mA$
Static Drain-Source On-Resistance (Note 7)	R _{DS(ON)}		_	30		$V_{GS} = 5V, I_D = 100mA$
Forward Transconductance (Notes 7 & 9)	g _{fs}	100	_	_	mS	$V_{DS} = 25V, I_D = 250mA$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	_	85		$V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz
Output Capacitance	Coss	_	_	20	pF	
Reverse Transfer Capacitance	C _{rss}	_	_	7		
Turn-On Delay Time (Note 8)	t _{D(ON)}	_	_	7		V _{DD} = 25V, I _D = 250mA
Turn-On Rise Time (Note 8)	t _R	_	_	8		
Turn-Off Delay Time (Note 8)	t _{D(OFF)}		_	16	ns	
Turn-Off Fall Time (Note 8)	t _F	_	_	8		

Notes: 7. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

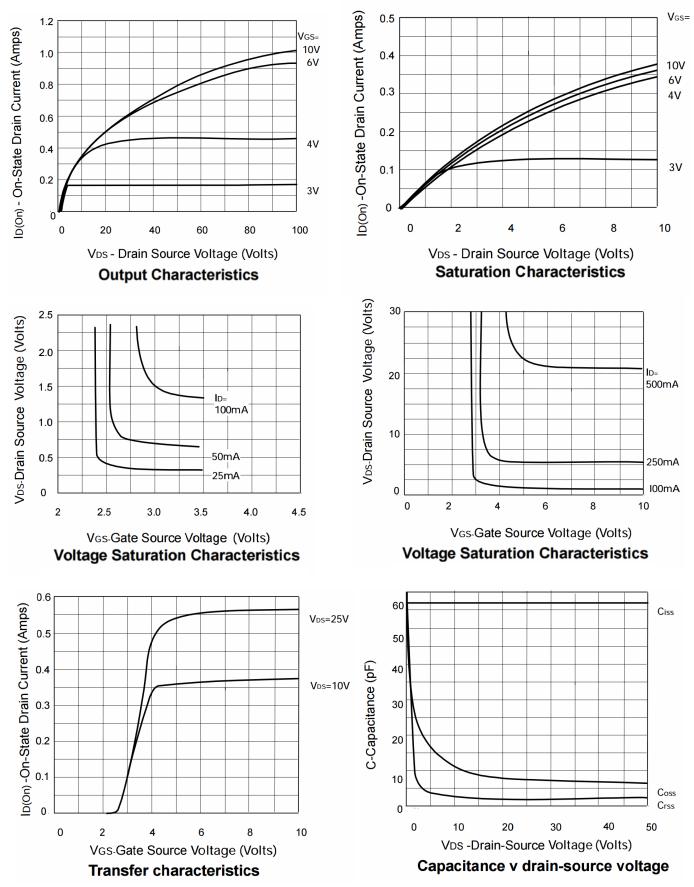
8. Switching characteristics are independent of operating junction temperature. Switching times are measured with 50Ω source impedance and <5ns rise time on a pulse generator.

9. For design aid only, not subject to production testing.



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Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

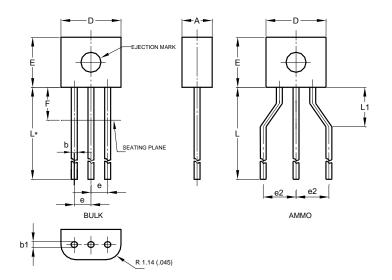




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Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



E-Line					
Dim	Min	Max	Тур		
Α	2.16	2.41	-		
b	0.41	0.495	-		
b1	0.41	0.495	_		
D	4.37	4.77	-		
Е	3.61	4.01	-		
е	-	-	1.27		
e2	-	-	2.54		
F	-	2.50	-		
L	13.00	13.97	-		
L1	2.50	3.50	-		
All Dimensions in mm					



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